

## 10A, 600V N-CHANNEL MOSFET

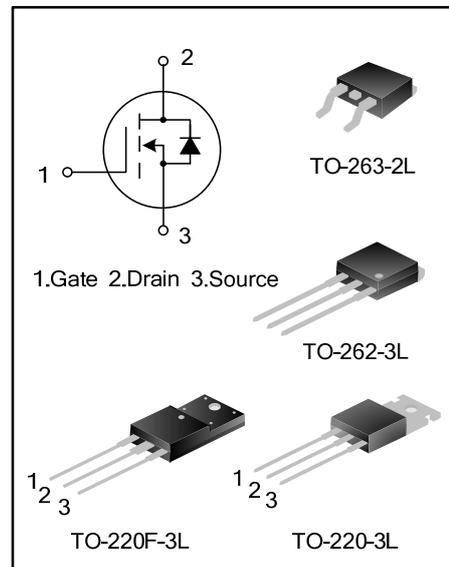
### GENERAL DESCRIPTION

SVF10N60T/F/FG/S/K is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan proprietary F-Cell™ structure VDMOS technology. The improved planar stripe cell and the improved guard ring terminal have been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

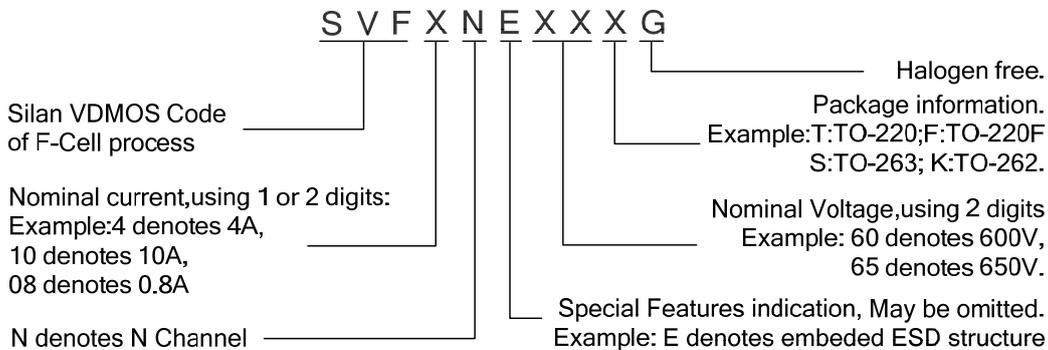
These devices are widely used in AC-DC power suppliers, DC-DC converters and H-bridge PWM motor drivers.

### FEATURES

- \* 10A,600V, $R_{DS(on)(typ.)}=0.75\Omega@V_{GS}=10V$
- \* Low gate charge
- \* Low Crss
- \* Fast switching
- \* Improved dv/dt capability



### NOMENCLATURE



### ORDERING INFORMATION

Part No.	Package	Marking	Material	Packing
SVF10N60T	TO-220-3L	SVF10N60T	Pb free	Tube
SVF10N60F	TO-220F-3L	SVF10N60F	Pb free	Tube
SVF10N60FG	TO-220F-3L	SVF10N60FG	Halogen free	Tube
SVF10N60S	TO-263-2L	SVF10N60S	Pb free	Tube
SVF10N60STR	TO-263-2L	SVF10N60S	Pb free	Tape & Reel
SVF10N60K	TO-262-3L	SVF10N60K	Pb free	Tube

### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub>=25°C unless otherwise noted)

Characteristics	Symbol	Ratings				Unit
		SVF10N 60T	SVF10N 60F(G)	SVF10N 60S	SVF10N 60K	
Drain-Source Voltage	V <sub>DS</sub>	600				V
Gate-Source Voltage	V <sub>GS</sub>	±30				V
Drain Current	I <sub>D</sub>	10				A
		7				
Drain Current Pulsed	I <sub>DM</sub>	40				A
Power Dissipation(T <sub>C</sub> =25°C) -Derate above 25°C	P <sub>D</sub>	156	50	150	148	W
		1.25	0.4	1.20	1.18	W/°C
Single Pulsed Avalanche Energy (Note 1)	E <sub>AS</sub>	654				mJ
Operation Junction Temperature Range	T <sub>J</sub>	-55~+150				°C
Storage Temperature Range	T <sub>stg</sub>	-55~+150				°C

### THERMAL CHARACTERISTICS

Characteristics	Symbol	Ratings				Unit
		SVF10N 60T	SVF10N 60F(G)	SVF10N 60S	SVF10N 60K	
Thermal Resistance, Junction-to-Case	R <sub>θJC</sub>	0.8	2.5	0.83	0.84	°C/W
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub>	62.5	120	62.5	62.5	°C/W

### ELECTRICAL CHARACTERISTICS (T<sub>C</sub>=25°C unless otherwise noted)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain -Source Breakdown Voltage	B <sub>VDS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	600	--	--	V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =600V, V <sub>GS</sub> =0V	--	--	1.0	μA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V	--	--	±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> =250μA	2.0	--	4.0	V
Static Drain- Source On State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =5.0A	--	0.75	1.0	Ω
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHZ	--	1132	--	pF
Output Capacitance	C <sub>oss</sub>		--	135	--	
Reverse Transfer Capacitance	C <sub>rss</sub>		--	3.91	--	
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =300V, I <sub>D</sub> =10A, R <sub>G</sub> =25Ω  (Note 2,3)	--	32.33	--	ns
Turn-on Rise Time	t <sub>r</sub>		--	60.40	--	
Turn-off Delay Time	t <sub>d(off)</sub>		--	58.67	--	
Turn-off Fall Time	t <sub>f</sub>		--	38.67	--	
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =480V, I <sub>D</sub> =10A, V <sub>GS</sub> =10V  (Note 2,3)	--	19.38	--	nC
Gate-Source Charge	Q <sub>gs</sub>		--	6.26	--	
Gate-Drain Charge	Q <sub>gd</sub>		--	6.55	--	

**SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS**

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	$I_S$	Integral Reverse p-n	--	--	10	A
Pulsed Source Current	$I_{SM}$	Junction Diode in the MOSFET	--	--	40	
Diode Forward Voltage	$V_{SD}$	$I_S=10A, V_{GS}=0V$	--	--	1.3	V
Reverse Recovery Time	$T_{rr}$	$I_S=10A, V_{GS}=0V,$	--	535.39	--	ns
Reverse Recovery Charge	$Q_{rr}$	$dI_F/dt=100A/\mu S$ (Note 2)	--	4.6	--	$\mu C$

**Notes:**

1.  $L=30mH, I_{AS}=6.0A, V_{DD}=150V, R_G=25\Omega,$  starting  $T_J=25^\circ C;$
2. Pulse Test: Pulse width  $\leq 300\mu s,$  Duty cycles  $\leq 2\%;$
3. Essentially independent of operating temperature.

**TYPICAL CHARACTERISTICS**

Figure 1. On-Region Characteristics

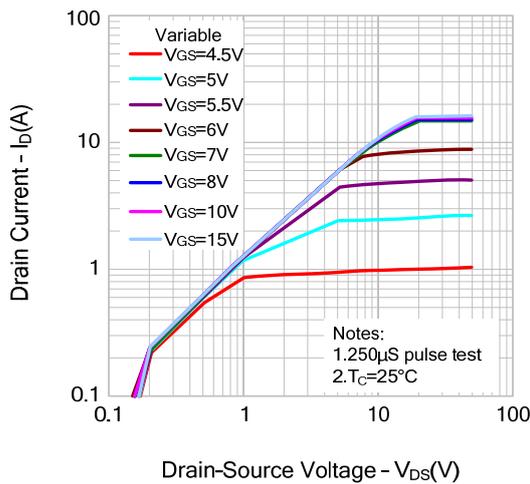


Figure 2. Transfer Characteristics

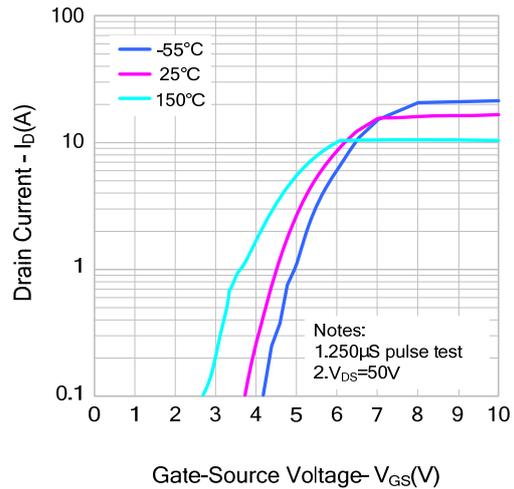


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

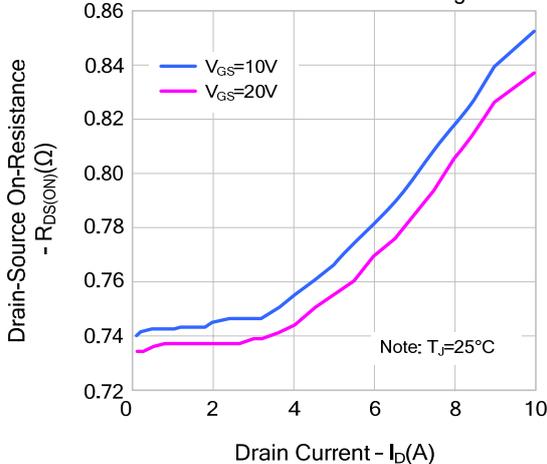
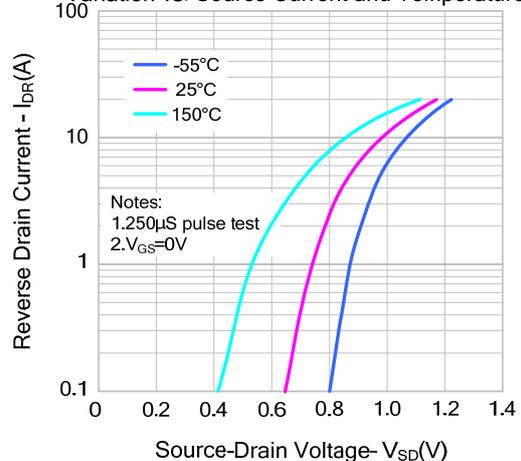


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature





**TYPICAL CHARACTERISTICS (continued)**

Figure 5. Capacitance Characteristics

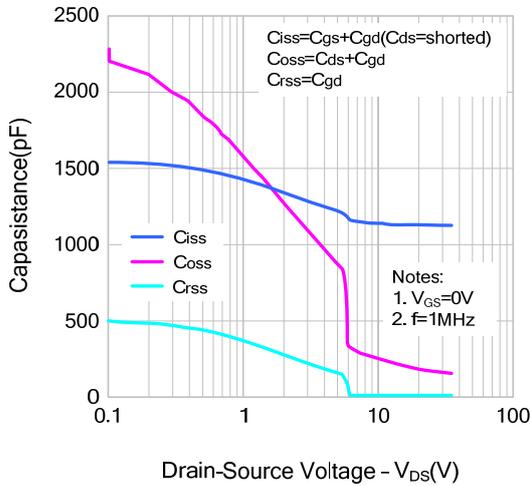


Figure 6. Gate Charge Characteristics

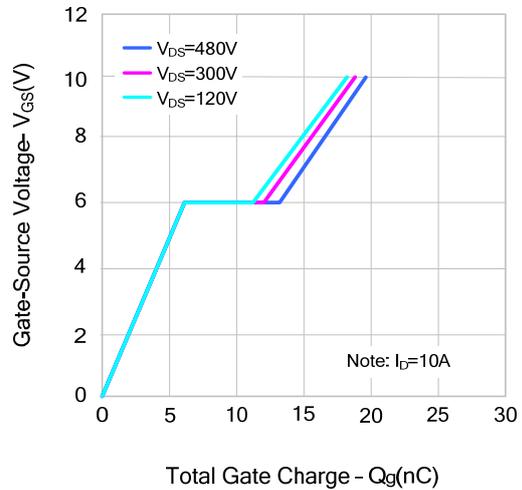


Figure 7. Breakdown Voltage Variation vs. Temperature

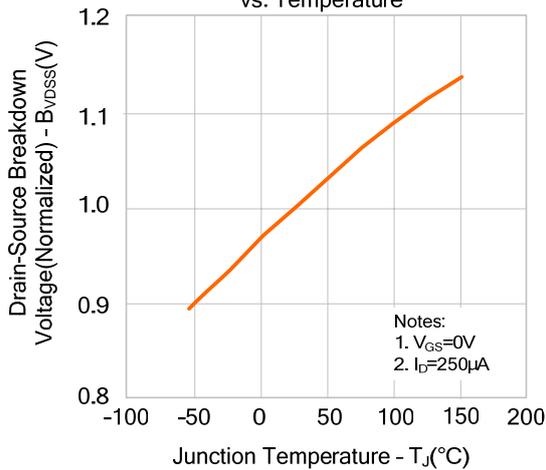


Figure 8. On-resistance Variation vs. Temperature

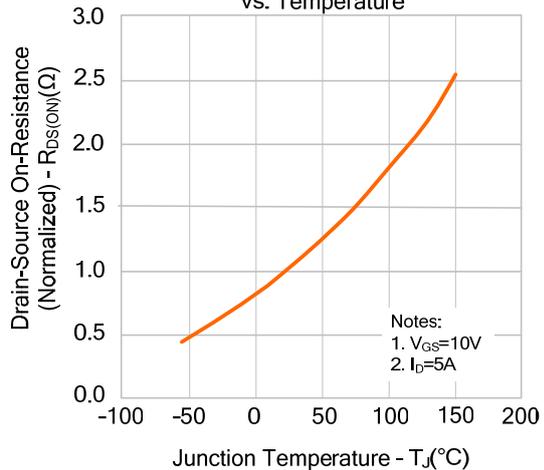


Figure 9-1. Max. Safe Operating Area(SVF10N60T)

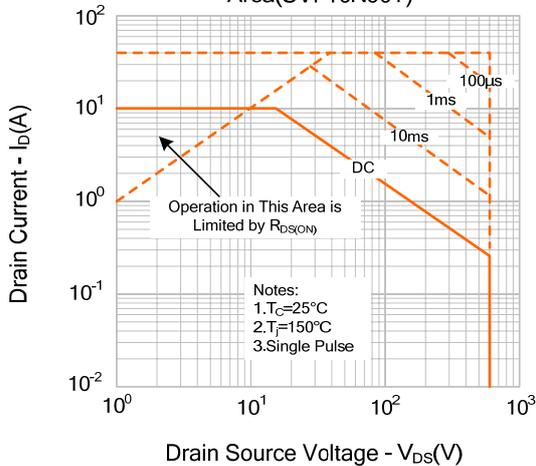
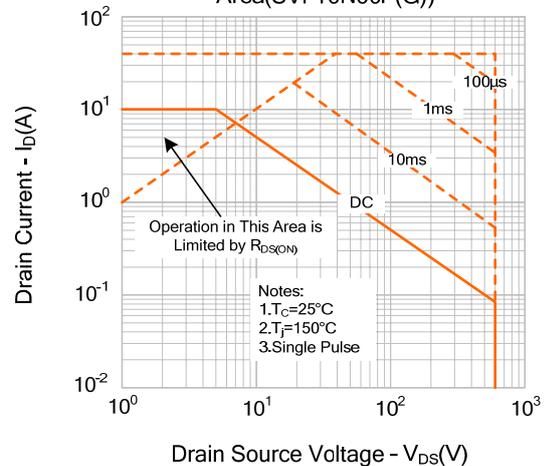
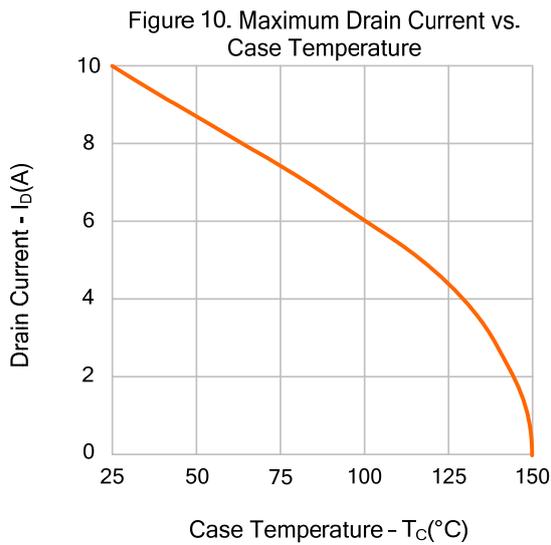
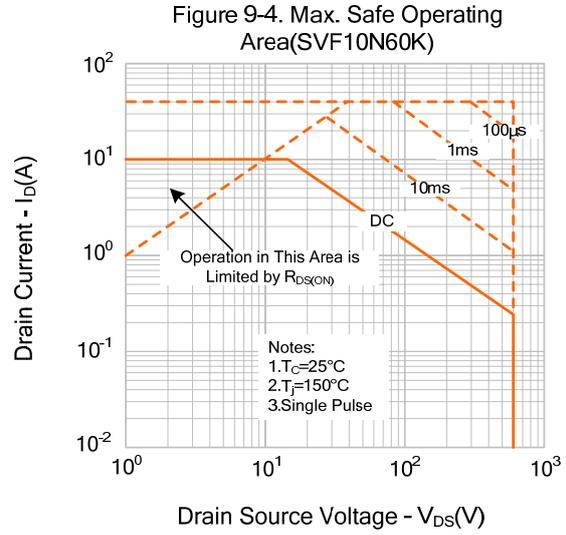
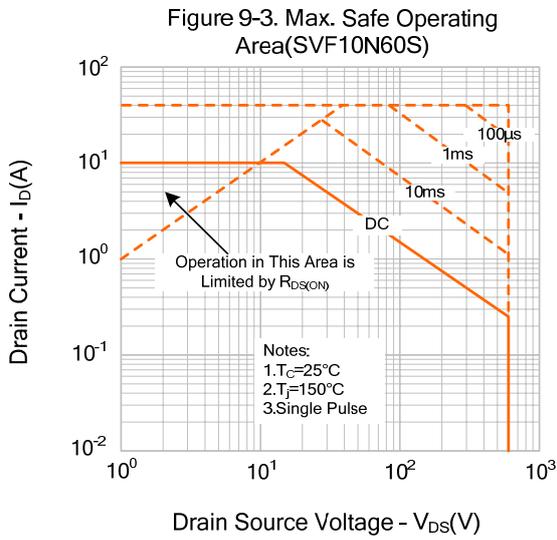


Figure 9-2. Max. Safe Operating Area(SVF10N60F(G))



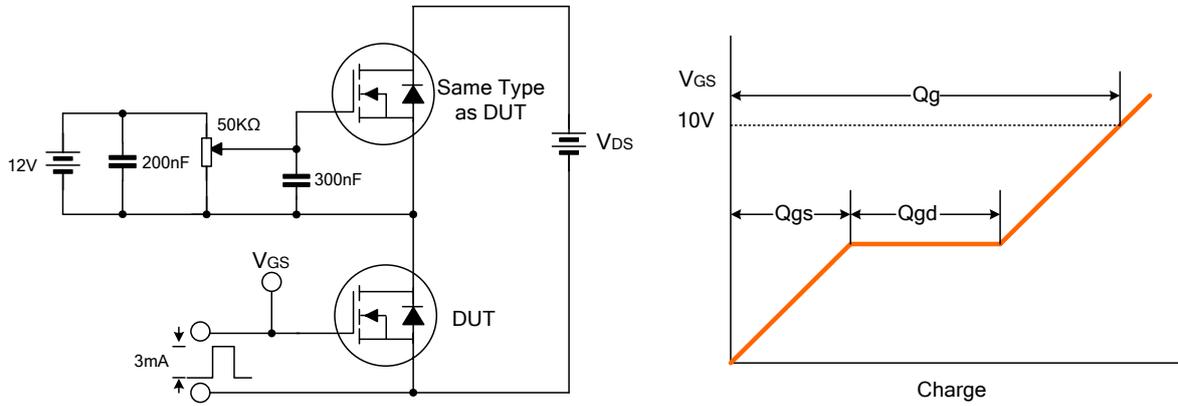


## TYPICAL CHARACTERISTICS (continued)

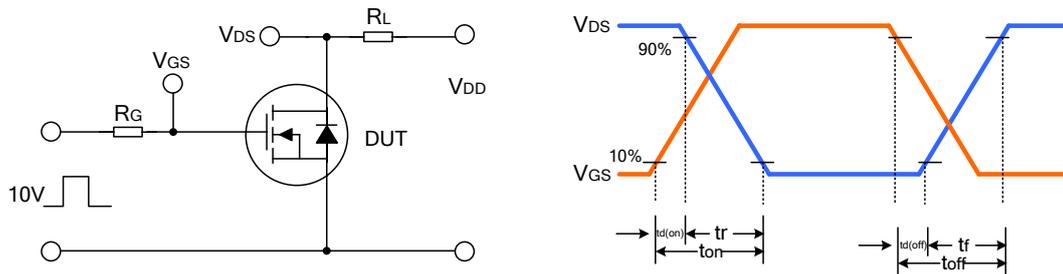


**TYPICAL TEST CIRCUIT**

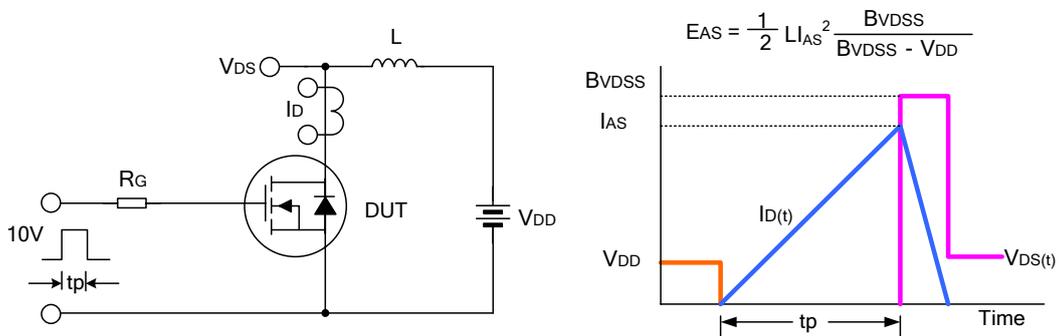
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



Unclamped Inductive Switching Test Circuit & Waveform

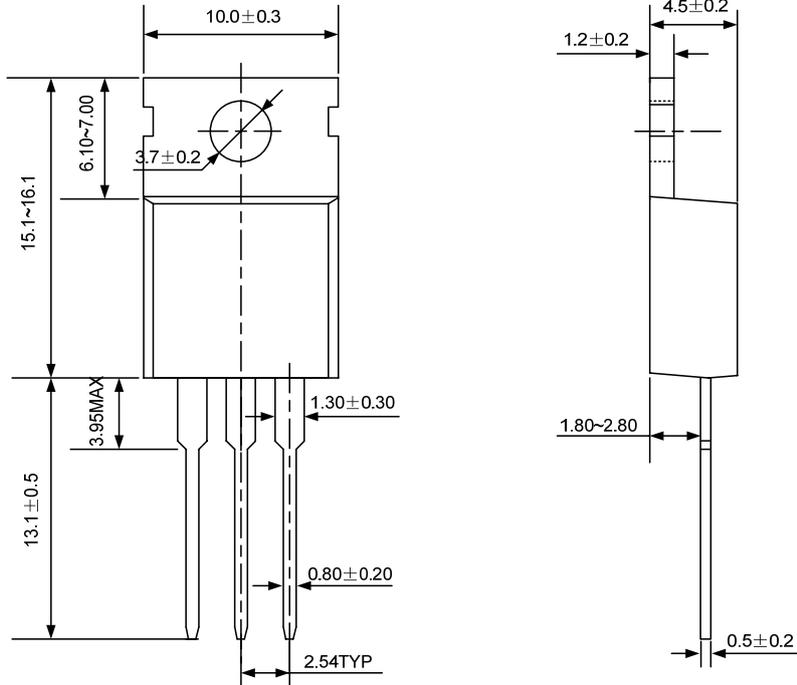




## PACKAGE OUTLINE

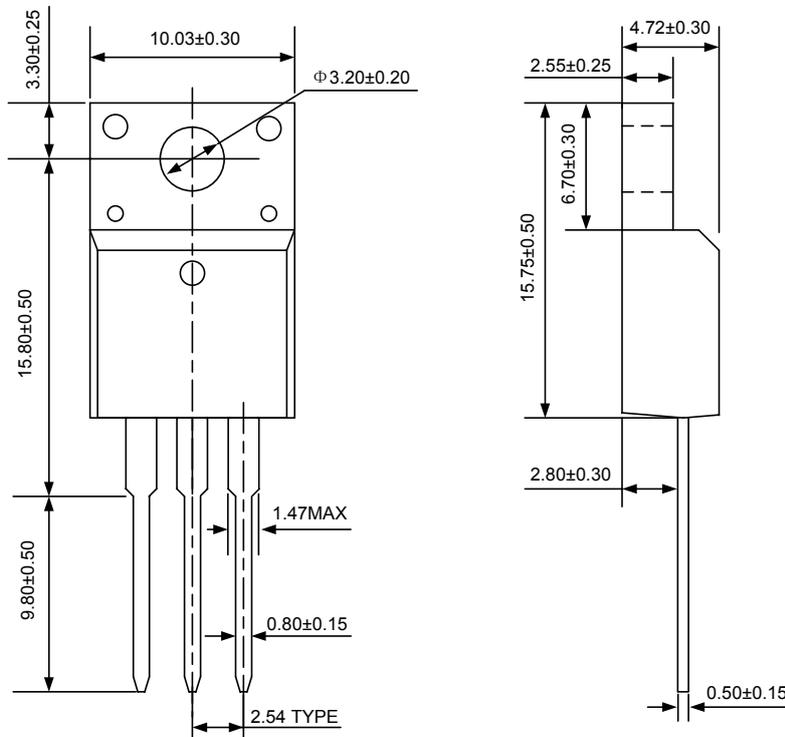
TO-220-3L

UNIT: mm



TO-220F-3L

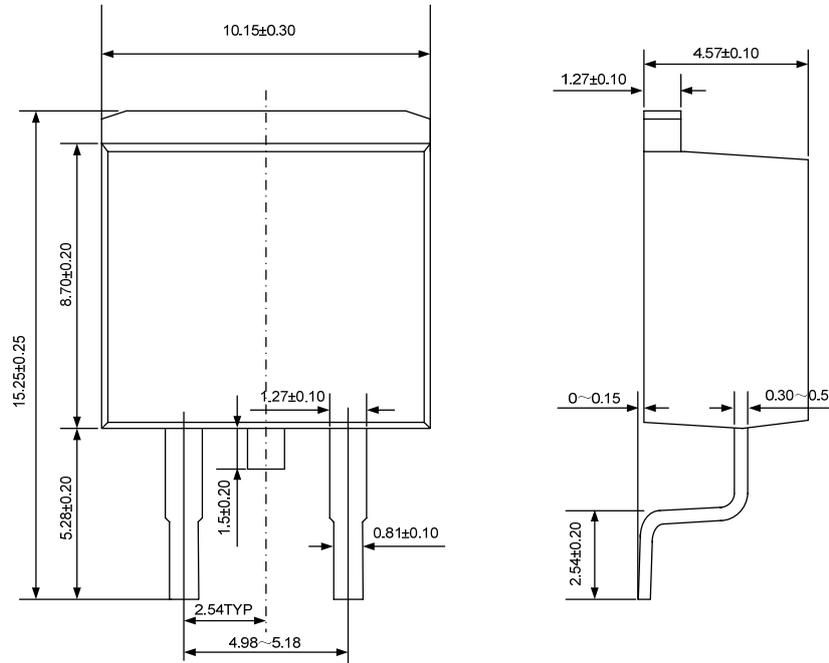
UNIT: mm



**PACKAGE OUTLINE(continued)**

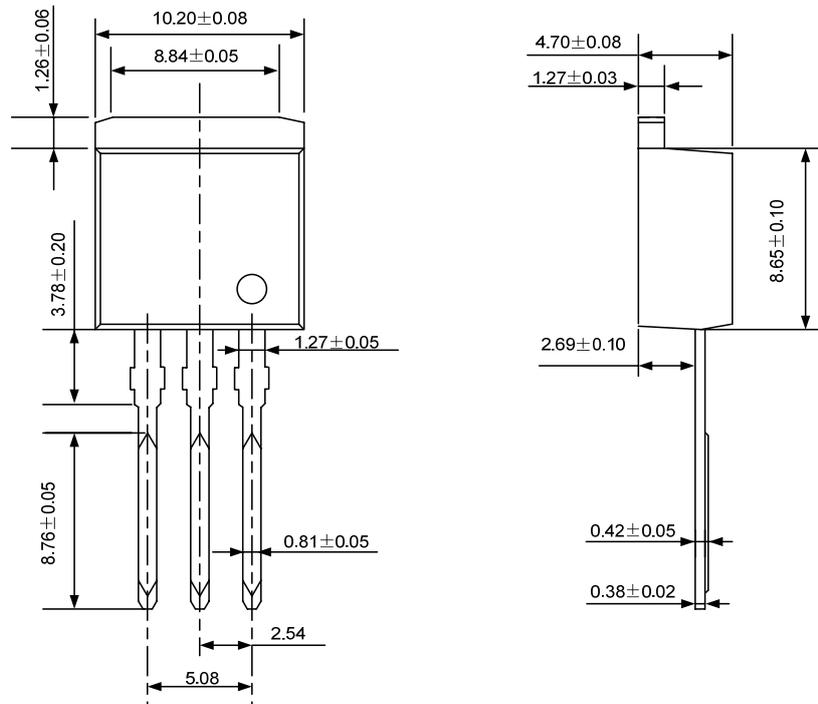
**TO-263-2L**

**UNIT: mm**



**TO-262-3L**

**UNIT: mm**





**Disclaimer:**

- Silan reserves the right to make changes to the information herein for the improvement of the design and performance without further notice! Customers should obtain the latest relevant information before placing orders and should verify that such information is complete and current.
- All semiconductor products malfunction or fail with some probability under special conditions. When using Silan products in system design or complete machine manufacturing, it is the responsibility of the buyer to comply with the safety standards strictly and take essential measures to avoid situations in which a malfunction or failure of such Silan products could cause loss of body injury or damage to property.
- Silan will supply the best possible product for customers!

## ATTACHMENT

### Revision History

Date	REV	Description	Page
2011.01.24	1.0	Original	
2011.05.17	1.1	Add the package of TO-263-2L	
2011.09.02	1.2	Modify "PACKAGE OUTLINE"	
2012.01.18	1.3	Add the package of TO-262-3L	
2012.04.11	1.4	Add the halogen free information of SVF10N60F	
2012.06.04	1.5	Modify the values of $T_{rr}$ and $Q_{rr}$	